

3.3V CMOS Low Jitter XO



Actual Size $= 5 \times 7$ mm



Product Features

- Less than 1.5 ps RMS jitter with non-PLL design
- 3.3V CMOS/TTL compatible logic levels
- Pin-compatible with standard 5x7mm packages
- Designed for standard reflow and washing techniques
- Low power standby mode
- Pb-free and RoHS/Green compliant

Product Description

The FN Series includes a 3.3V crystal clock oscillator that achieves superb jitter and stability over a broad range of operating conditions and frequencies. The output clock signal, generated internally with a non-PLL oscillator design, is compatible with LVCMOS/LVTTL logic levels. The device, available on tape and reel, is contained in a 5x7mm surface-mount ceramic package.

Applications

The FN Series is an ideal reference clock for applications requiring low jitter or tight stability, including:

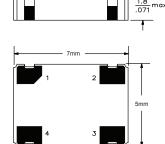
- Ethernet
- FibreChannel
- Serial Attached SCSI (SAS)
- Server & Storage platforms
- SONET/SDH linecards
- T1/E1, T3/E3 linecards
- DSLAM
- 802.11a/b/g WiFi



SaRonix-eCera



Packaging Outline



Pin Functions

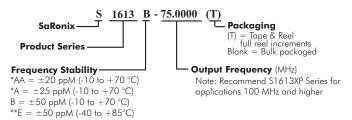
Pin	Function
1	OE Function
2	Ground
3	Clock Output
4	V_{DD}

New Part Number Example

A = Product Family B = Frequency Code C = Specification Code

Note: After July 1, 2007, a Saronix - eCera part number following the above format will be assigned upon confirmation of exact customer requirements.

Legacy Ordering Information (for reference only)



^{*} Availability varies by frequency





Electrical Performance

P	arameter	Min.	Тур.	Max.	Units	Notes	
Output frequen	ncy	1.544		156.25	MHz	As specified	
Supply voltage		+2.97	+3.3	+3.63	V		
				15	mA	1.544 to 32 MHz	
Cumple aumona				25		>32 to 50 MHz	
Supply current, output enabled				40		>50 to 80 MHz	
				55		>80 to 156.25 MHz	
Supply current	t, standby mode			10	μА	Output Hi-Z	
Frequency stal	oility			±20 to ±50	ppM	See Note 1 below	
Operating tem	perature	-40		+85	°C	As specified	
Output logic 0,	, VOL			10% V _{DD}	V		
Output logic 1,	, VOH	90% V _{DD}			V		
Output load	Output load		5 pF (ma	ax) or 10 LSTT			
Duty cycle (1.5	44 to 80 MHz)	45		55	%	-40 to +85°C measured 50%VDD	
Duty cycle (>80	Outy cycle (>80 to 156.25 MHz)			55	%	-10 to +70°C measured 50%VDD	
Duty cycle (>80	0 to 156.25 MHz)	40		60	%	-40 to-10°C, +70 to +85°C measured 50%VDD	
	up to 50 MHz			7			
Rise and fall	>50 to 80 MHz			5		120/000/ 6 6	
time	>80 to 125 MHz			3	ns	measured 20/80% of waveform	
	>125 to 156.25 MHz			2			
Jitter,	up to 80 MHz			1.5	ps RMS	10kHz to 20 MHz frequency band	
Phase	>80 to 156.25 MHz			1	(1-σ)		
Jitter,	up to 80 MHz			5	ps RMS	20.000 adjacent periods	
Accumulated	>80 to 156.25 MHz			3	(1-σ)		
Jitter,	up to 80 MHz			50	ps	100.000 random periods	
Total	>80 to 156.25 MHz			30	pk-pk		

Output Enable / Disable Function

Parameter	Min.	Тур.	Max.	Units	Notes
Input Voltage (pin 1), Output Enable	2.2			V	or open
Input voltage (pin 1), Output Disable (low power standby)			0.8	V	Output is Hi-Z
Internal pullup resistance	50			kΩ	
Output disable delay			100	ns	
Output enable delay			10	ms	

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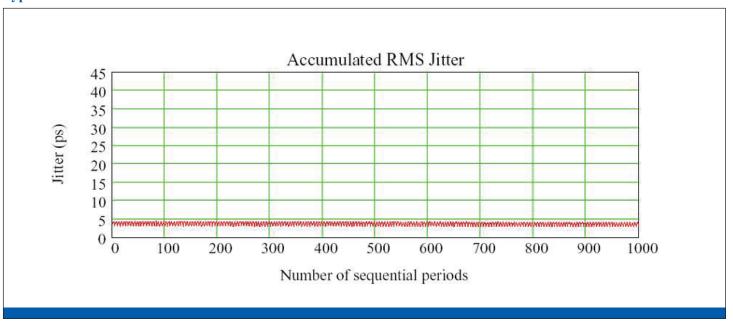
As specified. Stability includes all combinations of operating temperature, load changes, rated input (supply) voltage changes, initial calibration tolerance (25°C), aging (1 year at 25°C average effective ambient temperature), shock and vibration.

For specifications other than those listed, please contact sales.

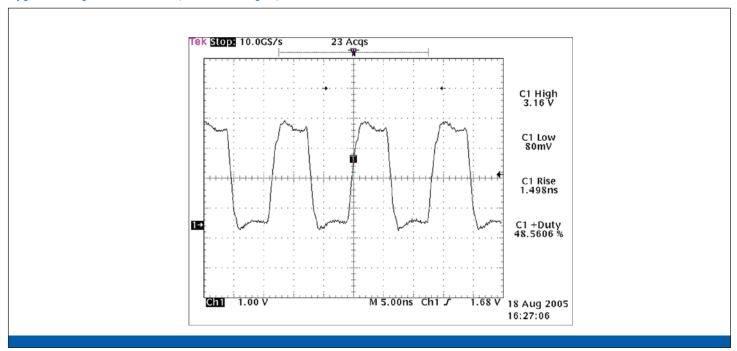




Typical Accumulated Jitter



Typical Output Waveform (75 MHz output)





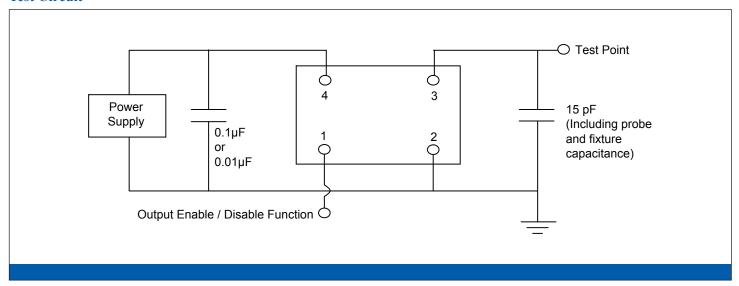




Absolute Maximum Ratings

Parameter	Min.	Тур.	Max.	Units	Notes
Storage temperature	-55		+125	°C	

Test Circuit



Reliability Test Ratings

This product is rated to meet the following test conditions:

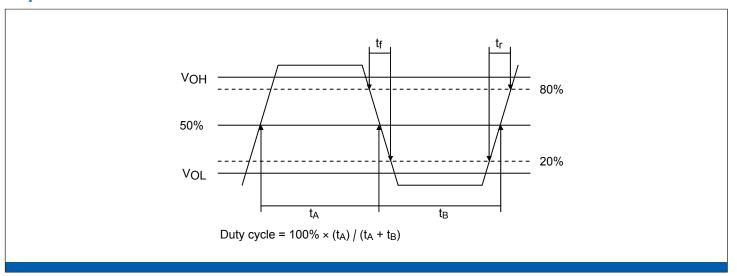
Туре	Parameter	Test Condition
Mechanical	Shock	MIL-STD-883, Method 2002, Condition B
Mechanical	Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Mechanical	Terminal strength	MIL-STD-883, Method 2004, Condition D
Mechanical	Gross leak	MIL-STD-883, Method 1014, Condition C
Mechanical	Fine leak	MIL-STD-883, Method 1014, Condition A2 ($R_1 = 2x10^{-8}$ atm cc/s)
Mechanical	Solvent resistance	MIL-STD-202, Method 215
Environmental	Thermal shock	MIL-STD-883, Method 1011, Condition A
Environmental	Moisture resistance	MIL-STD-883, Method 1004
Environmental	Vibration	MIL-STD-883, Method 2007, Condition A
Environmental	Resistance to soldering heat	J-STD-020C Table 5-2 Pb-free devices (2 cycles max)



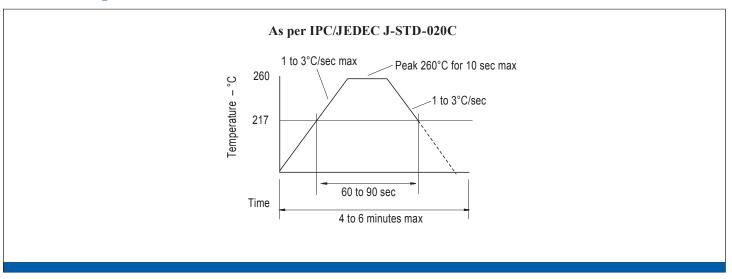




Output Waveform



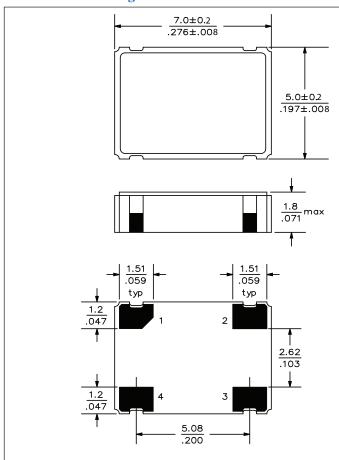
Reflow Soldering Profile



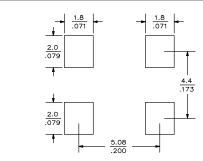




Mechanical Drawings



Recommended Land Pattern*



*External high-frequency power decoupling is recommended.(see test circuit for minimum recommendation). To ensure optimal performance, do not route traces beneath the package.

Scale: None. Dimensions are in mm/inches.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated:

FNA000081 FNC500132A FNC500170 FND300014 FND330013 FNF620057J FNC500001 FNC500137

FNF620046J FN3330036 FN4000091 FN4000133 FN4800001 FN4800006 FN4800036 FN5000137 FN5000146

FN6600026 FN6600029 FN6660026 FN6660040 FN7060009 FN7420006 FN7770008 FN7770032 FNC500006

FNC500011 FNC500140 FND330008 FNC500125 FNE850001 FNC500151 FN0180036 FN1000045

FN1470038Q FN1660008 FN1800005 FN1840016 FN2000095 FN2400027 FN2450028 FN2450038 FN2500100

FN2500164 FN2500184 FN2500194 FN2500247J FN3220004 FN4800046 FN4910029 FN5330007 FN6550008

FN8000061 FN9830015 FNC500053 FNC500088 FNC500169 FNA620006 FNF620040A FN4800008 FN5000005

FN7420010Q FN7770010 FNA000064A FNC500020 FNC500030 FNC500139 FNC500141 FN5000154

FN6600031 FN6660046 FN7410001 FNC500043 FNC500138 FND300017 FN2500174 FN2500217Z FN2600024

FN3000032 FN3300056 FN4800065 FN5400002 FN6400002 FN6600061 FN6600065 FN6660072 FN8330023

FN9000002 FNA000087 FN3300068 FN3330070 FN3840009 FN4000169 FN5000106 FN7500051 FN8330021

FN9000013 FNA000085Q FNC500111 FNC500123A